



Precision, Low Power, G = 10, 100 INSTRUMENTATION AMPLIFIER

FEATURES

● LOW OFFSET VOLTAGE: 50µV max

LOW DRIFT: 0.5μV/°C max

● ACCURATE GAIN: ±0.05% at G = 10

LOW INPUT BIAS CURRENT: 5nA max

• HIGH CMR: 117dB min

■ INPUTS PROTECTED TO ±40V

● WIDE SUPPLY RANGE: ±2.25 to ±18V

● LOW QUIESCENT CURRENT: 750µA

• 8-PIN PLASTIC DIP, SO-8

APPLICATIONS

- BRIDGE AMPLIFIER
- THERMOCOUPLE AMPLIFIER
- RTD SENSOR AMPLIFIER
- MEDICAL INSTRUMENTATION
- DATA ACQUISITION

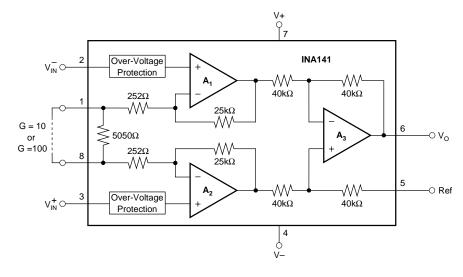
DESCRIPTION

The INA141 is a low power, general purpose instrumentation amplifier offering excellent accuracy. Its versatile 3-op amp design and small size make it ideal for a wide range of applications. Current-feedback input circuitry provides wide bandwidth even at high gain (200kHz at G=100).

Simple pin connections set an accurate gain of 10 or 100V/V without external resistors. Internal input protection can withstand up to $\pm 40V$ without damage.

The INA141 is laser trimmed for very low offset voltage (50 μ V), drift (0.5 μ V/°C) and high common-mode rejection (117dB at G = 100). It operates with power supplies as low as ± 2.25 V, and quiescent current is only 750 μ A—ideal for battery operated systems.

The INA141 is available in 8-pin plastic DIP, and SO-8 surface-mount packages, specified for the -40°C to +85°C temperature range.



International Airport Industrial Park • Mailing Address: PO Box 11400, Tucson, AZ 85734 • Street Address: 6730 S. Tucson Blvd., Tucson, AZ 85706 • Tel: (520) 746-1111 • Twx: 910-952-1111
Internet: http://www.burr-brown.com/ • FAXLine: (800) 548-6133 (US/Canada Only) • Cable: BBRCORP • Telex: 066-6491 • FAX: (520) 889-1510 • Immediate Product Info: (800) 548-6132



SPECIFICATIONS

At T_A = +25°C, V_S = ± 15 V, and R_L = 10k Ω , unless otherwise noted.

			INA141P, U		ı	NA141PA, UA	<u> </u>	
PARAMETER	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNITS
INPUT Offset Voltage, RTI vs Temperature vs Power Supply Long-Term Stability Impedance, Differential Common-Mode Common-Mode Voltage Rang Safe Input Voltage Common-Mode Rejection	$G = 100$ $G = 10$ $G = 100$ $G = 10^{(2)}$ $V_S = \pm 2.25 \text{ to } \pm 18V, G = 100$ $G = 10$ $G = 100$ $G = 10$ $V_O = 0V$ $V_{CM} = \pm 13V, \Delta R_S = 1k\Omega$ $G = 100$	(V+) - 2 (V-) + 2	±20 ±50 ±0.2 ±0.5 ±0.4 ±2 0.2 0.5 10 ¹⁰ 2 10 ¹⁰ 9 (V+) - 1.4 (V-) + 1.7	±50 ±100 ±0.5 ±2 ±1 ±10	* *	* * * * * * * * * * * * * * * * * * *	±125 ±250 ±1.5 ±2.5 ±3 ±20	μV μV°C μV/°C μV/V μV/V μV/N μV/mo μV/mo μ pF Ω pF V V
	G = 10	100	106		93	100		dB
BIAS CURRENT vs Temperature Offset Current vs Temperature			±2 ±30 ±1 ±30	±5 ±5		* * * *	±10 ±10	nA pA/°C nA pA/°C
NOISE VOLTAGE, RTI $f = 10Hz$ $f = 10Hz$ $f = 10Hz$ $f = 1kHz$ $f_B = 0.1Hz \text{ to } 10Hz$ $f = 0.1Hz \text{ to } 10Hz$ Noise Current $f = 10Hz$ $f = 10Hz$ $f = 10Hz$ $f = 0.1Hz \text{ to } 10Hz$	$G = 100, R_S = 0\Omega$ $G = 10, R_S = 0\Omega$		10 8 8 0.2 22 13 12 0.6			****		nV/√Hz nV/√Hz nV/√Hz pV/-P nV/√Hz nV/√Hz nV/√Hz μVp-p pA/√Hz pA/√Hz pA/-P
GAIN Gain Error Gain vs Temperature ⁽²⁾ Nonlinearity	V _O = ±13.6V, G = 100 G = 10 G = 10, 100 G = 100 G = 10		±0.03 ±0.01 ±2 ±0.0005 ±0.0003	±0.075 ±0.05 ±10 ±0.002 ±0.001		* * * * * *	±0.15 ±0.15 * ±0.004 ±0.002	% % ppm/°C % of FSR % of FSR
OUTPUT Voltage: Positive Negative Load Capacitance Stability Short-Circuit Current	$R_L = 10$ kΩ $R_L = 10$ kΩ	(V+) - 1.4 (V-) + 1.4	(V+) - 0.9 (V-) + 0.9 1000 +6/-15		*	* * * *		V V pF mA
FREQUENCY RESPONSE Bandwidth, -3dB Slew Rate Settling Time, 0.01% Overload Recovery	G = 100 G = 10 $V_O = \pm 10V, G = 10$ $V_O = \pm 5V, G = 100$ G = 10 50% Overdrive		200 1 4 9 7 4			* * * * *		kHz MHz V/μs μs μs μs
POWER SUPPLY Voltage Range Current, Total	V _{IN} = 0V	±2.25	±15 ±750	±18 ±800	*	*	*	V μA
	40.11	-40 -40	80 150	85 125	* *	* *	* *	°C °C °C/W °C/W

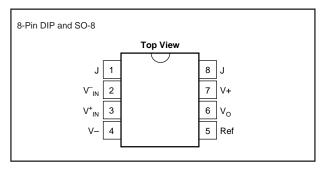
 $[\]ensuremath{\boldsymbol{\ast}}$ Specification same as INA141P, U.

NOTE: (1) Input common-mode range varies with output voltage—see typical curves. (2) Guaranteed by wafer test.

The information provided herein is believed to be reliable; however, BURR-BROWN assumes no responsibility for inaccuracies or omissions. BURR-BROWN assumes no responsibility for the use of this information, and all use of such information shall be entirely at the user's own risk. Prices and specifications are subject to change without notice. No patent rights or licenses to any of the circuits described herein are implied or granted to any third party. BURR-BROWN does not authorize or warrant any BURR-BROWN product for use in life support devices and/or systems.



PIN CONFIGURATION



ABSOLUTE MAXIMUM RATINGS

Supply VoltageAnalog Input Voltage Range	
Output Short-Circuit (to ground)	
Operating Temperature	40°C to +125°C
Storage Temperature	40°C to +125°C
Junction Temperature	+150°C
Lead Temperature (soldering, 10s)	+300°C



This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER ⁽¹⁾	TEMPERATURE RANGE		
INA141PA	8-Pin Plastic DIP	006	-40°C to +85°C		
INA141P	8-Pin Plastic DIP	006	-40°C to +85°C		
INA141UA	SO-8 Surface-Mount	182	-40°C to +85°C		
INA141U	SO-8 Surface-Mount	182	-40°C to +85°C		

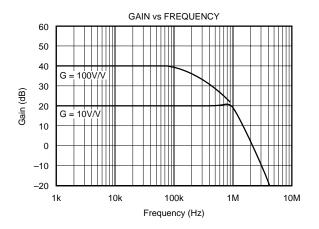
NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix C of Burr-Brown IC Data Book.

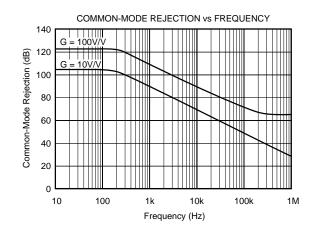
BURR-BROWN®

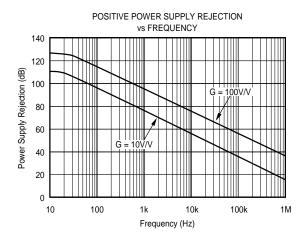
INA141

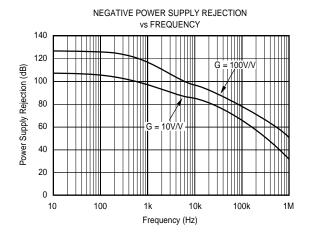
3

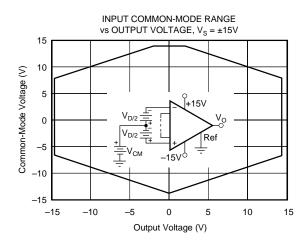
TYPICAL PERFORMANCE CURVES

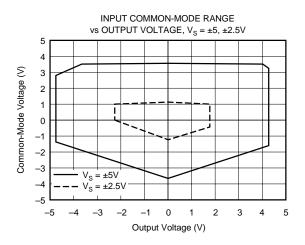






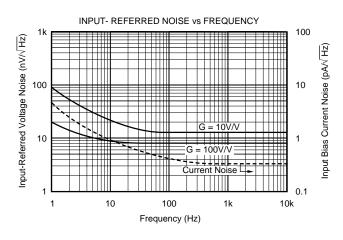


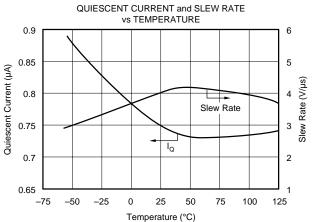


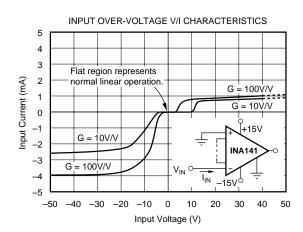


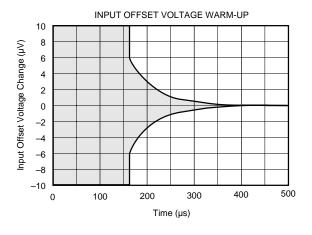


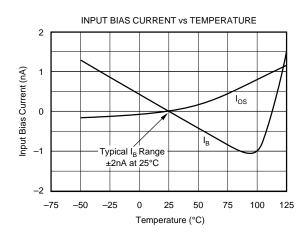
TYPICAL PERFORMANCE CURVES (CONT)

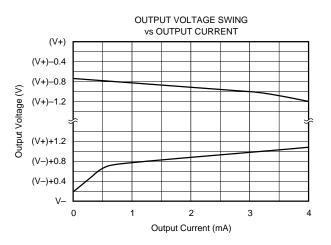




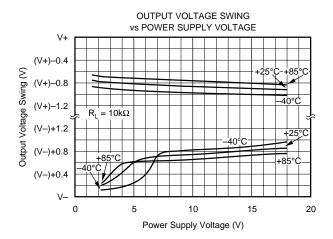


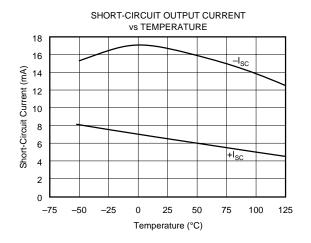


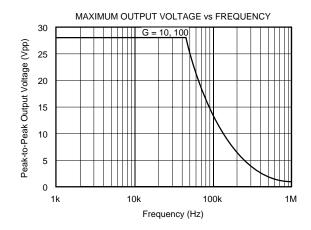


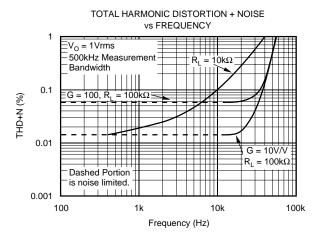


TYPICAL PERFORMANCE CURVES (CONT)

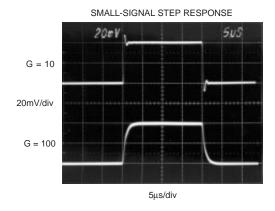


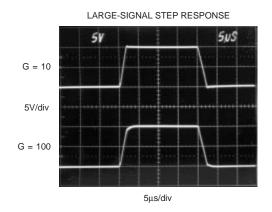


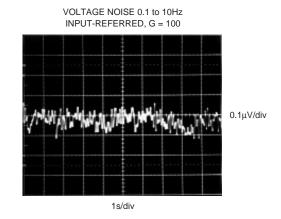




TYPICAL PERFORMANCE CURVES (CONT)







APPLICATION INFORMATION

Figure 1 shows the basic connections required for operation of the INA141. Applications with noisy or high impedance power supplies may require decoupling capacitors close to the device pins as shown.

The output is referred to the output reference (Ref) terminal which is normally grounded. This must be a low-impedance connection to assure good common-mode rejection. A resistance of 8Ω in series with the Ref pin will cause a typical device to degrade to approximately 80dB CMR (G = 1).

SETTING THE GAIN

Gain is selected with a jumper connection as shown in Figure 1. G=10V/V with no jumper installed. With a jumper installed, G=100V/V. To preserve good gain accuracy, this jumper must have low series resistance. A resistance of 0.5Ω in series with the jumper will decrease the gain by 0.1%.

Internal resistor ratios are laser trimmed to assure excellent gain accuracy. Actual resistor values can vary by approximately $\pm 25\%$ from the nominal values shown.

Gains between 10 and 100 can be achieved by connecting an external resistor to the jumper pins. This is not recommended, however, because the ±25% variation of internal resistor values makes the required external resistor value uncertain. A companion model, INA128, features accurately trimmed internal resistors so that gains from 1 to 10,000 can be set with an external resistor.

DYNAMIC PERFORMANCE

The typical performance curve "Gain vs Frequency" shows that, despite its low quiescent current, the INA141 achieves wide bandwidth, even at G=100. This is due to the current-feedback topology of the INA141. Settling time also remains excellent at G=100.

NOISE PERFORMANCE

The INA141 provides very low noise in most applications. Low frequency noise is approximately $0.2\mu Vp$ -p measured from 0.1 to 10Hz (G = 100). This provides dramatically improved noise when compared to state-of-the-art chopper-stabilized amplifiers.

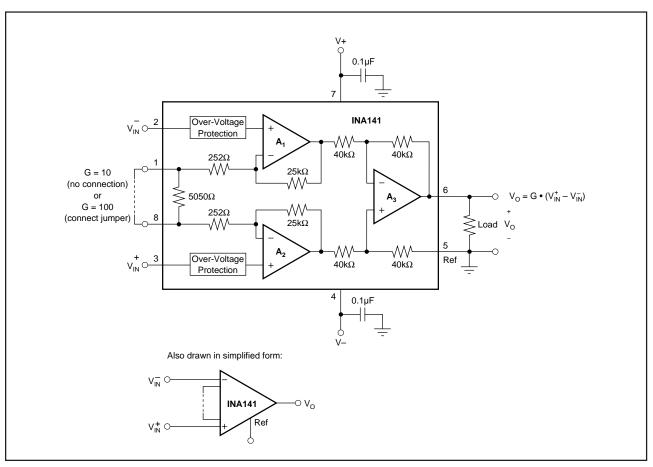


FIGURE 1. Basic Connections.



OFFSET TRIMMING

The INA141 is laser trimmed for low offset voltage and offset voltage drift. Most applications require no external offset adjustment. Figure 2 shows an optional circuit for trimming the output offset voltage. The voltage applied to Ref terminal is summed with the output. The op amp buffer provides low impedance at the Ref terminal to preserve good common-mode rejection.

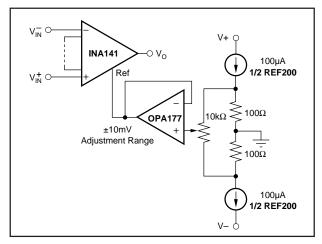


FIGURE 2. Optional Trimming of Output Offset Voltage.

INPUT BIAS CURRENT RETURN PATH

The input impedance of the INA141 is extremely high—approximately $10^{10}\Omega$. However, a path must be provided for the input bias current of both inputs. This input bias current is approximately $\pm 2nA$. High input impedance means that this input bias current changes very little with varying input voltage.

Input circuitry must provide a path for this input bias current for proper operation. Figure 3 shows various provisions for an input bias current path. Without a bias current path, the inputs will float to a potential which exceeds the commonmode range of the INA141 and the input amplifiers will saturate.

If the differential source resistance is low, the bias current return path can be connected to one input (see the thermocouple example in Figure 3). With higher source impedance, using two equal resistors provides a balanced input with possible advantages of lower input offset voltage due to bias current and better high-frequency common-mode rejection.

INPUT COMMON-MODE RANGE

The linear input voltage range of the input circuitry of the INA141 is from approximately 1.4V below the positive supply voltage to 1.7V above the negative supply. As a differential input voltage causes the output voltage to increase, however, the linear input range will be limited by the output voltage swing of amplifiers A_1 and A_2 . So the linear common-mode input range is related to the output voltage of the complete amplifier. This behavior also depends on supply voltage—see performance curves "Input Common-Mode Range vs Output Voltage".

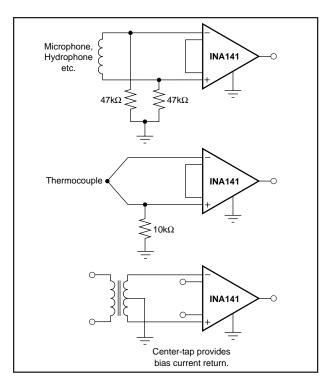


FIGURE 3. Providing an Input Common-Mode Current Path.

Input overload can produce an output voltage that appears normal. For example, if an input overload condition drives both input amplifiers to their positive output swing limit, the difference voltage measured by the output amplifier will be near zero. The output of the INA141 will be near 0V even though both inputs are overloaded.

LOW VOLTAGE OPERATION

The INA141 can be operated on power supplies as low as ± 2.25 V. Performance remains excellent with power supplies ranging from ± 2.25 V to ± 18 V. Most parameters vary only slightly through this supply voltage range—see Typical Performance Curves. Operation at very low supply voltage requires careful attention to assure that the input voltages remain within their linear range. Voltage swing requirements of internal nodes limit the input common-mode range with low power supply voltage. Typical performance curves, "Input Common-Mode Range vs Output Voltage" show the range of linear operation for ± 15 V, ± 5 , and ± 2.5 V supplies.

INPUT PROTECTION

The inputs of the INA141 are individually protected for voltages up to ± 40 V. For example, a condition of -40V on one input and +40V on the other input will not cause damage. Internal circuitry on each input provides low series impedance under normal signal conditions. To provide equivalent protection, series input resistors would contribute excessive noise. If the input is overloaded, the protection circuitry limits the input current to a safe value of approximately 1.5 to 5mA. The typical performance curve "Input Bias Current vs Common-Mode Input Voltage" shows this input current limit behavior. The inputs are protected even if the power supplies are disconnected or turned off.

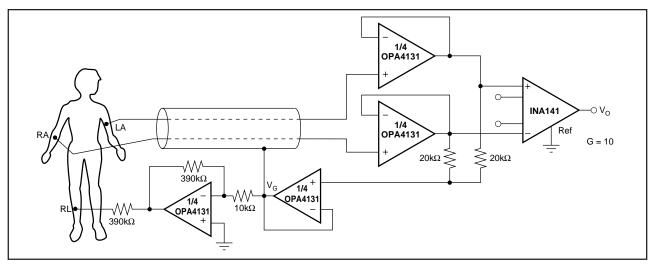


FIGURE 4. ECG Amplifier With Right-Leg Drive.

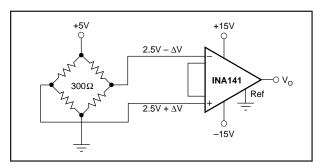


FIGURE 5. Bridge Amplifier.

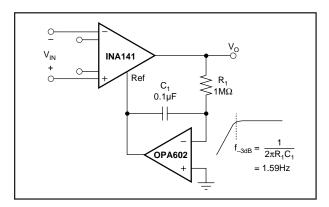


FIGURE 6. AC-Coupled Instrumentation Amplifier.

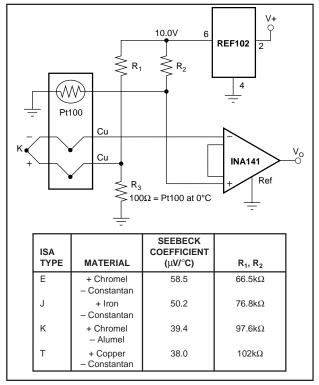


FIGURE 7. Thermocouple Amplifier With RTD Cold-Junction Compensation.

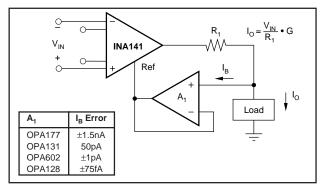


FIGURE 8. Differential Voltage to Current Converter.



PACKAGE OPTION ADDENDUM

www.ti.com 16-Apr-2009

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
INA141P	OBSOLETE	PDIP	Р	8		TBD	Call TI	Call TI
INA141PA	OBSOLETE	PDIP	Р	8		TBD	Call TI	Call TI
INA141U	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA141U/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA141U/2K5E4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA141UA	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA141UA/2K5	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA141UA/2K5E4	ACTIVE	SOIC	D	8	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA141UAE4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA141UAG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR
INA141UG4	ACTIVE	SOIC	D	8	75	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-3-260C-168 HR

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.



TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
INA141U/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
INA141UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1





*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
INA141U/2K5	SOIC	D	8	2500	346.0	346.0	29.0	
INA141UA/2K5	SOIC	D	8	2500	346.0	346.0	29.0	

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Applications Products Amplifiers amplifier.ti.com Audio www.ti.com/audio Data Converters Automotive www.ti.com/automotive dataconverter.ti.com DLP® Products Broadband www.dlp.com www.ti.com/broadband DSP Digital Control dsp.ti.com www.ti.com/digitalcontrol Clocks and Timers www.ti.com/clocks Medical www.ti.com/medical Military Interface www.ti.com/military interface.ti.com Optical Networking Logic logic.ti.com www.ti.com/opticalnetwork Power Mgmt power.ti.com Security www.ti.com/security Telephony Microcontrollers microcontroller.ti.com www.ti.com/telephony Video & Imaging www.ti-rfid.com www.ti.com/video RF/IF and ZigBee® Solutions www.ti.com/lprf Wireless www.ti.com/wireless

> Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2009, Texas Instruments Incorporated

AMEYA360 Components Supply Platform

Authorized Distribution Brand:

























Website:

Welcome to visit www.ameya360.com

Contact Us:

> Address:

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

> Sales:

Direct +86 (21) 6401-6692

Email amall@ameya360.com

QQ 800077892

Skype ameyasales1 ameyasales2

Customer Service :

Email service@ameya360.com

Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com